TLP3041(S),TLP3042(S),TLP3043(S)

OFFICE MACHINE HOUSEHOLD USE EQUIPMENT TRIAC DRIVER SOLID STATE RELAY

The TOSHIBA TLP3041 (S), TLP3042 (S), TLP3043 (S) consist of a zero voltage crossing turn-on photo-triac optically coupled to an infrared emitting diode in a six lead plastic DIP package.

Peak Off-State Voltage : 400 V (min)

: 15 mA (max) (TLP3041(S)) Trigger LED Current

10 mA (max) (TLP3042(S))

5 mA (max) (TLP3043(S))

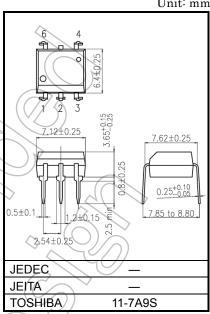
On-State Current : 100 mA (max) Isolation Voltage : 5000 Vrms (min)

UL-recognized : UL 1577, File No.E67349

: CSA Component Acceptance Service No.5A cUL-recognized

File No.E67349

: EN 60747-5-5, EN 62368-1 (Note 1) VDE-approved



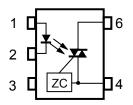
weight: 0.39g (typ.)

Note 1: When a VDE approved type is needed, please designate the Option (D4).

Construction mechanical rating

	7.62 mm pitch Standard Type	10.16 mm pitch TLPxxxxF Type
Creepage Distance Clearance	7.0 mm (Min) 7.0 mm (Min)	8.0 mm (Min) 8.0 mm (Min)
Insulation Thickness	0.5 mm (Min)	0.5 mm (Min)

Pin Configuration (top view)



- 1: Anode
- 2: Cathode
- 3: N.C.
- 4:Terminal 1
- 6:Terminal 2

ZC:Zero-cross Circuit

Start of commercial production 1986-11

Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERIST	IC	SYMBOL	RATING	UNIT
	Forward Current		lF	50	mA
	Forward Current Derati (Ta ≥ 53°C)			-0.7	mA / °C
Peak Forward Current (100μs pulse, 100pps)			IFP	1	Α
LED	Reverse Voltage		VR	5	V
	Power Dissipation		PD	100	mW
	Power Dissipation Dera (Ta ≥ 25°C)	ting	ΔP _D / °C	-1.0	mW / °C
	Junction Temperature		Tj	125	°C
	Off-State Output Termi	Off-State Output Terminal Voltage		400	V((
	On-Stage RMS	Ta = 25°C		100	
	Current	Ta = 70°C	I _{T(RMS)}	50	mA
~	On-State Current Derating (Ta ≥ 25°C)		ΔI _T / °C	-1.1	mA/°C
DETECTOR	Peak On-Stage Current (100μs pulse, 120pps)	t	ITP	2	
DET	Peak Nonrepetitive Sur Current (P _W = 10ms)	ge	I _{TSM}	1(2	A
	Power Dissipation		PD	300	mW
	Power Dissipation Dera (Ta ≥ 25°C)	ting	ΔP _D / °C	-4.0	mW / °C
	Junction Temperature		Tj (115	~c \
Stora	age Temperature Range		T _{stg}	-55 to 150/	°C/
Operating Temperature Range			Topr	−40 to 100	√ °C)
Lead Soldering Temperature (10 s)			(T _{sol})	260	,e\
Total Package Power Dissipation			PT	330	mW
Total Package Power Dissipation Derating (Ta ≥ 25°C)			ΔPτ / °C	-4.4	mW / °C
	tion Voltage 60 s., R.H. ≤ 60 %)	(Note 1)	BVs	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two terminal device: Pins 1, 2 and 3 shorted together and pins 4 and 6 shorted together.

Recommended Operating Conditions

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	VAC	_	_	120	Vac
Forward Current	l _F *	15	20	25	mA
Peak On-Stage Current	ITP	_	_	1	Α
Operating Temperature	Topr	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

*: In the case of TLP3042

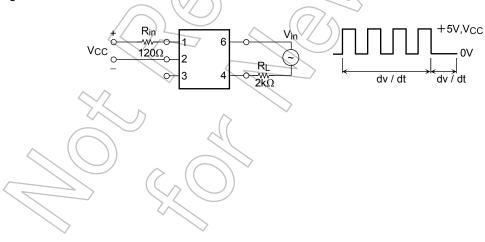
Individual Electrical Characteristics (Ta = 25°C)

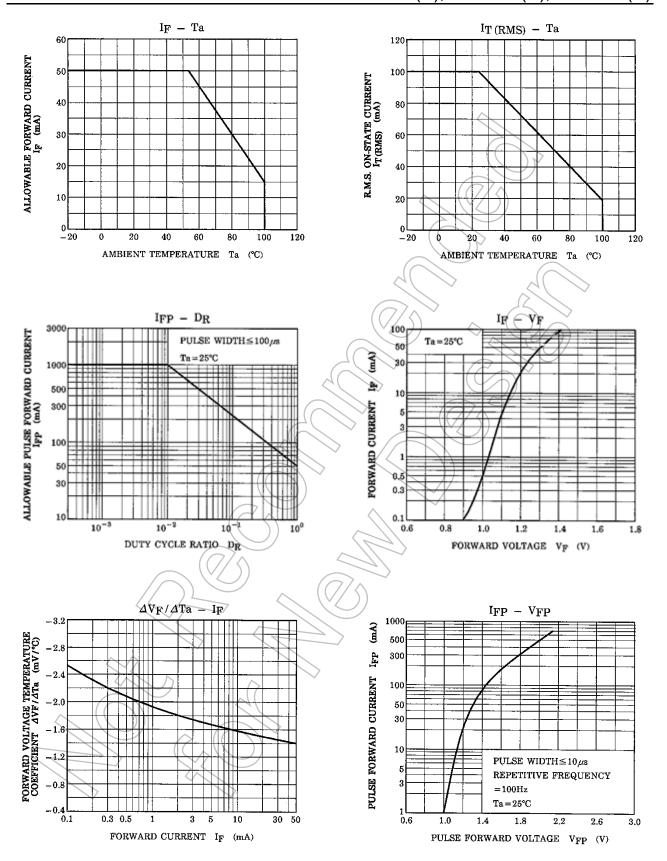
	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Forward Voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	I _R	V _R = 5 V	_	_	10	μΑ
	Capacitance	Ст	V = 0 V, f = 1 MHz	/	10	_	pF
	Peak Off-State Current	IDRM	V _{DRM} = 400 V		10	100	nA
œ	Peak On-Stage Voltage	V _{TM}	I _{TM} = 100 mA		1.7	3.0	V
STOI	Holding Current	lн	(7)) })	0.6	_	mA
DETECTOR	Critical Rate of Rise of Off- State Voltage	dv / dt	V _{in} = 120 Vrms, Ta = 85 °C (Fig.1)	200	500	_	V / μs
	Critical Rate of Rise of Commutating Voltage	dv / dt(c)	V _{in} = 30 Vrms, IT = 15 mA (Fig.1)	_	0.2	_	V / μs

Coupled Electrical Characteristics (Ta = 25°C)

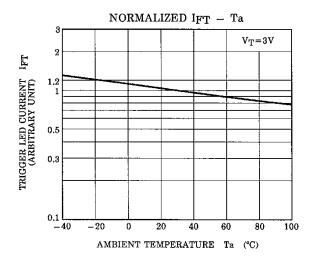
CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN	TYP)	MAX	UNIT
	TLP3041(S)				79/	15	
Trigger LED Current	TLP3042(S)	IFT	VT = 3 V		5	10	mA
	TLP3043(S)			4	_	5	
Inhibit Voltage		V _{IH}	IF = Rated IFT	_	1	40	٧
Leakage in Inhibited State	9	in the second	I _F = Rated I _{FT} V _T = Rated V _{DRM}	1	100	300	μΑ
Capacitance Input to Out	put	Cs	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation Resistance		Rs	V _S = 500V, R.H. ≤ 60 %)	5×10 ¹⁰	10 ¹⁴	_	Ω
Isolation Voltage		BVs	AC, 60 s	5000		_	Vrms

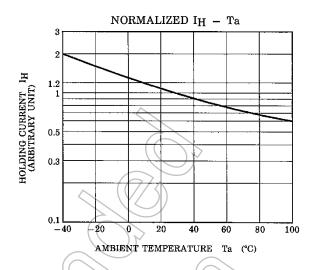
Fig. 1 dv / dt test circuit

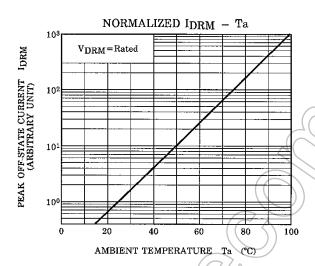


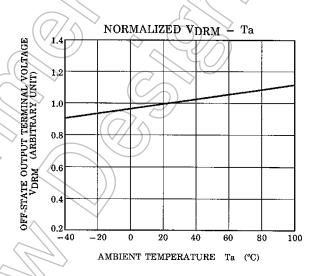


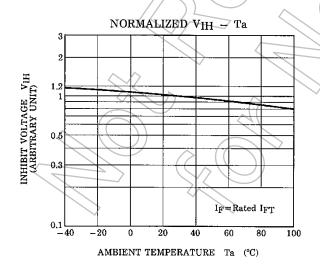
NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

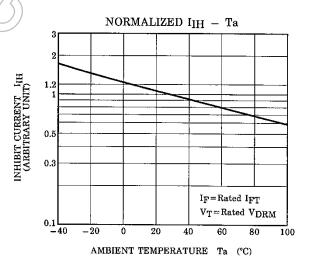












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